

3.2x1.6mm SMD CHIP LED LAMP

Features

- \bullet Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- \bullet MSL (Moisture Sensitivity Level): 3
- RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Polarity Mark 1. 6(0.063) 1. 6(0.063) 1. 0.5(0.024) 1. 0.5(0.022) 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.2(0.008") unless otherwise noted.

Absolute Maximum Ratings (T _A =25°C)	CBD (InGaN)	Unit		
Reverse Voltage	V_{R}	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	P_{D}	120	mW	
Operating Temperature	$T_{\rm A}$	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Electrostatic Discharge Threshold (HBM)	250	V		

Operating Characteristics (T _A =25°C)	CBD (InGaN)	Unit		
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	3.3	V	
Forward Voltage (Max.) (I _F =20mA)	V_{F}	4	V	
Reverse Current (Max.) $(V_R=5V)$	I_R	50	uA	
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)	λΡ	460*	nm	
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I _F =20mA)	λD	465*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$\triangle \lambda$	25	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	pF	

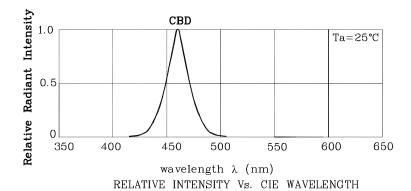
Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} Luminous \ Intensity \\ CIE127\text{-}2007* \\ (I_F\text{=}20\text{mA}) \\ mcd \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
ZCBD55W-3	Blue	InGaN	Water Clear	300*	695*	460*	35°

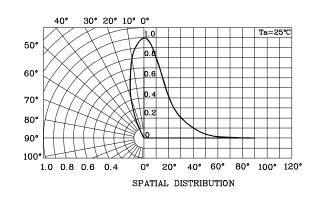
3. Specifications are subject to change without notice.

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

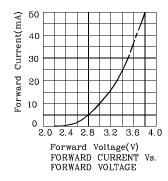


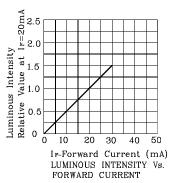


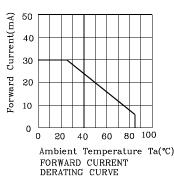


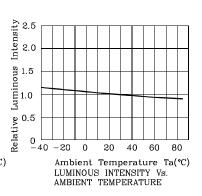


♦ CBD



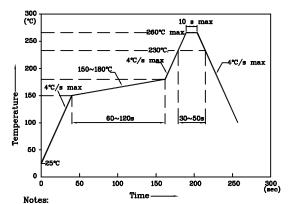






LED is recommended for reflow soldering and soldering profile is shown below.

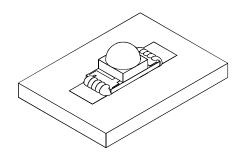
Reflow Soldering Profile for SMD Products (Pb-Free Components)



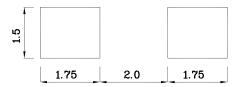
- 1. Maximum soldering temperature should not exceed 260°C
- 2. Recommended reflow temperature: 145°C-260°C
- 3. Do not put stress to the epoxy resin during high temperatures conditions



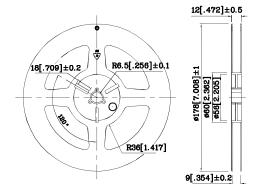
❖ The device has a single mounting surface. The device must be mounted according to the specifications.



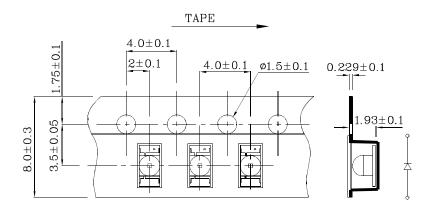
♦ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



❖ Reel Dimension



❖ Tape Specification (Units:mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

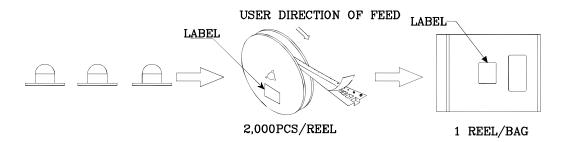
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

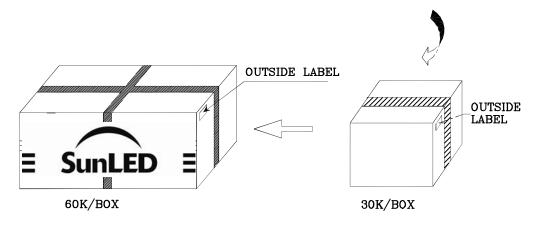
Note: Accuracy may depend on the sorting parameters.

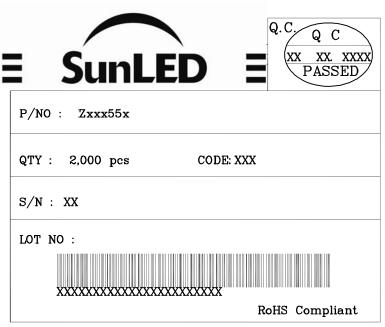




PACKING & LABEL SPECIFICATIONS







TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- 6. Additional technical notes are available at http://www.SunLED.com/TechnicalNotes

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